Form PTO 1449	ATTY. DOCKET NUMBER NITT.0063 SERIAL NUMBER To Be Assigned		PTO
U.S. Department of Commerce Patent and Trademark Office	APPLICANT KATAGIRI et al.		1.s. 121 121 5/02
Information Disclosure Statement by Applicant	FILING DATE Concurrently Herewith	GROUP	10/0 10/0

U.S. Patent Documents

Examiner	DOCUMENT	DATE	Name	CLASS	SUBC	FILING DATE
Initial	Number				LASS	
AL	5,770,095	6/23/1998	Sasaki et al.			7/11/1995
M	5,972,792	10/26/1999	Hudson			10/18/1996
NZ.	4,954,142	1/28/1992	Nenadic et al.			2/23/1999

Foreign Patent Documents

Examiner	DOCUMENT NUMBER	FILING DATE	Country	CLASS	Sub-	TRANSLATION	
Initial					CLASS	YES	No
AR	2-278822	3/7/1990	Japan	-			X
AR	8-83780	3/26/1996	Japan	·			Χ
An	2000-049122	7/30/1998	Japan			- Abs.	X

Other Documents (Including Author, Title, Date Pertinent Pages, Etc.)

AR	Vilas Koinkar, Reza Golzarian, Quiliang Luo, Matthew Van Hanechem, Jim Shen and Peter Burke, "Chemical mechanical planarization of copper interconnects using fixed abrasive polishing pad," 2000 Chemical Mechanical Planarization for ULSI Multilevel Interconnection Conference", March 2000, pp. 58-65			
AR	"New material and process technology for next generation ULSI multi-layered wirings", Technical Information Society, pp. 242-246			
Examiner	DATE CONSIDERED 04/02/03			

EXAMINER: Initial if citation is considered, whether or not citation is in conformance with MPEP 609; draw a line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant

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